



34.9	33.5	30	39-29-8131	5268-13A-X	13
29.9	28.5	25	-8111	-11A-X	11
24.9	23.5	20	-8091	-09A-X	9
19.9	18.5	15	-8071	-07A-X	7
17.4	16	12.5	-8061	-06A-X	6
14.9	13.5	10	-8051	-05A-X	5
12.4	11	7.5	-8041	-04A-X	4
9.9	8.5	5	-8031	-03A-X	3
C	B	A	EDP NO.	ENG. NO.	NO. OF CKTS.

NOTES

- I. MATES WITH : 5264 SERIES
- △ APPLIES : PIN, BOTH ENDS

REVISED EC NO: J2016-0761 DRWR: TANAKA02 2016/01/20 CHKD: SAKIYAMA 2016/02/03 APPR: KANEKO 2016/02/09	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 5:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
	0.25 UNDER	UNDER	± 0.03	DRAWN BY T. ITO	DATE 1991/12/06	TITLE 2.5 LOW PROFILE WAFER ASSY 90 DEGREES BEND	
	0.25 OVER	0.5 UNDER	± 0.05	CHECKED BY M. FUKUSHIMA	DATE 1992/08/31	MATERIAL NO. SEE CHART	
	0.5 OVER	1.0 UNDER	± 0.1	APPROVED BY	DATE	DOCUMENT NO. SD-5268-NA-X	
	1.0 OVER	10 UNDER	± 0.2	SIZE A3		SHEET NO. 1 OF 1	
10 OVER	30 UNDER	± 0.25	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				
30 OVER		± 0.3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				